



Product Specification

Ningbo East Electronics Limited

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Product Name:	SMD External-Driven Piezo Transducer
Part Number:	SFM-1435
Version:	1.03
Date:	2019-10-8
Note:	

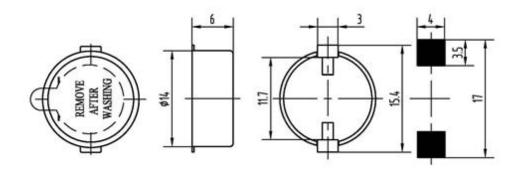
East is an ISO 9001, IATF16949 and ISO 14001Certified Company

Revision History

Rev.	Description	Author/Date	Checked By	Approver
1.03	Quality management system revised	汤礼东 2019-10-8	吕文斌	王建成
1.02	change the paper reel to plastic reel	刘进 2015-5-30	汤礼东	王建成
1.01	Quality Certificate Symbol revised	刘宁 2015-2-4	汤礼东	王建成

1. Part Number SFM-1435

2. Dimension Drawing (Unit: mm)



SFM-TERMINAL VERSION

RECOMMENDED SMD FOOT PATTERN

Solder paste thickness is not below 0.2mm The seal will be removed after reflow soldering

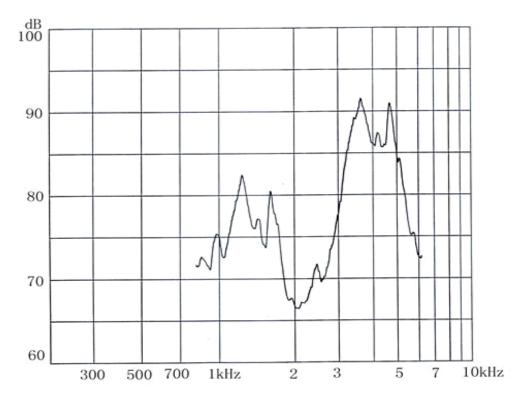
3. Specification

No.	Item	Specification
3-1	Min. Sound Pressure Level	80dB/3.5kHz/9Vp-p square wave /10cm
3-2	Allowed Input Voltage	15Vp-p
3-3	Capacitance	14±30%nF(At 1000Hz)
3-4	Max. Consumption	8mA/3.5kHz/9Vp-p square wave
3-5	Resonant Frequency	3.5± 0.5kHz
3-6	Operating Temperature	-20~+70°C
3-7	Case Material /Color	PPS/Black
3-8	Pin material/Plated	Cu/Sn
3-9	Weight	1g
3-10	Pin Strength	More than 10N

NOTES:

Test should be made under the conditions of room temperature $(20\pm10^{\circ}\text{C})$, normal humidity $(60\pm20\%)$ and normal atmospheric pressure. In this case, however, that the judgment is questionable, the test conditions are to be changed to room temperature $20\pm2^{\circ}\text{C}$, relative humidity $60\sim70\%$ and normal atmospheric pressure

4.Typical Frequency Response Curve



Note: Input Voltage 9Vp-p square wave

Distance 10 cm

5. Reliability Test

Item	Method of Test	Tolerance after Testing	
Operating Temperature	-20~+70°C	Sound pressure level initial value $\pm 10 dB$ Max. consumption value $\pm 20\%$ Capacitance value $\pm 20\%$	
Storage in high temperature	Storage in +70°C test box 96 hours then exposed to the room temperature for 2 hours		
Storage in low temperature	Storage in -20°C test box 96 hours then exposed to the room temperature for 2 hours		
Life test in the room temperature	Operate the product continuously 5 seconds on 5 seconds off 300 hours at rated voltage		
Temperature / humidity cycle test	Storage in +40°C, 93±3%RH test box 96 hours then exposed to the room temperature for 2 hours		
Temperature (high and low) cycle test	Conduct the test for 5 cycles without applying power then expose to the room temperature for 2 hours.(See Figure 5-6)		
Vibration test	Conduct the test for the directions of X Y and Z for 0.5 hour each (total 1.5 hours). To-and Fri sweep time(from 10 to 55Hz and then 55 to 10) under single amplitude of 0.75mm is 3 minute, then expose to the room temperature for 2 hours		
	Operating Temperature Storage in high temperature Storage in low temperature Life test in the room temperature Temperature / humidity cycle test Temperature (high and low) cycle test	Operating Temperature Storage in high temperature Storage in low temperature Storage in low temperature Storage in -20°C test box 96 hours then exposed to the room temperature Storage in low temperature Coperate the product continuously 5 seconds on 5 seconds off 300 hours at rated voltage Temperature / humidity cycle test Temperature (high and low) cycle test Conduct the test for 5 cycles without applying power then expose to the room temperature for 2 hours. Conduct the test for the directions of X Y and Z for 0.5 hour each (total 1.5 hours). To-and Fri sweep time(from 10 to 55Hz and then 55 to 10) under single amplitude of 0.75mm is 3	

5-8	Drop test	Drop a product naturally from the height of 700mm onto the surface of 100mm thick wooden board. Two directions: upper and side of the product are to be applied for this drop test once respectively	
5-9	Reflow soldering heat resistance	 a) Pre-heating conditions shall be +140°C to 160°C for 160 to 200 seconds. (See Figure5-9) b) Heating conditions shall be within 60 seconds at +200°C min., but peak temperature shall be lower than +260°C. (See Figure 5-9) 	
5-10	Test of soldering	Dip the connecting pins in soldering at 230±5°C for 3±0.5 seconds	Solder shall be attached around over 95% of the dipped portion

NOTE: The pins are allowed to deform after drop test.

Figure 5-6

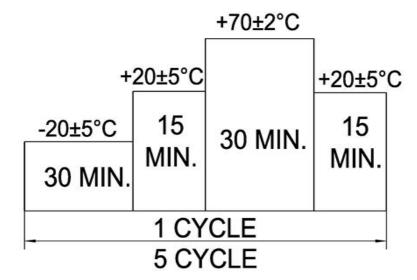
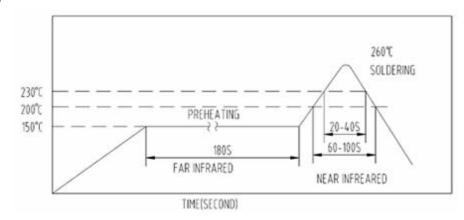
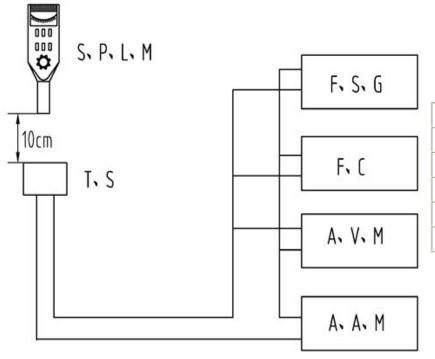


Figure 5-9



6. Electrical Testing Method



S.P.L.M	Sound Pressure Level Meter	
T.S	Testing Sample	
F.C	Frequency Counter	
F.S.G	Frequency Signal Generator	
A.V.M	AC Voltage Meter	
A.A.M	AC Ampere Meter	

7. Packing Information

	7.1 uching information			
No.	Item	Description		
7-1	Tape type information	 a) The design for such tape packing was executed under standard IEC - 286-3 b) The material of the tape is polystyrene in black color. Detailed dimensions are as below: (See Figure7-1) 		
7-2	Dimensions of the rolling plate	a) The material of the rolling plate is plastic.b) The dimensions of the rolling plate are as below(See Figure 7-2)		
7-3	Packing dimensions and quantity	 a) The rolling plate is put into a 340X335X35mm inner packing box and is packed with 500pcs of transducer per plate. b) The dimension of the outer carton is 400X 350X 350mm containing 10 inner boxes with a total quantity of 5000 pcs of transducer. c) The total gross weight per carton is 10.5Kgs, while net weight is 5.0Kgs. 		

Figure 7-1(Unit:mm)

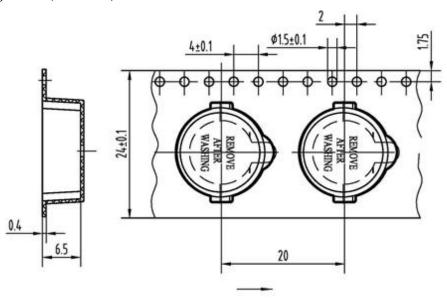


Figure 7-2(Unit:mm)

